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SERIAL NUMBER 10/618,220	FILING DATE 07/11/2003 RULE	CLASS 438	GROUP ART UNIT 2825	ATTORNEY DOCKET NO. MIO 0109 PA/04509.247/02-
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APPLICANTS

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** CONTINUING DATA *****

None, CAC

** FOREIGN APPLICATIONS *****

None, CAC

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

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Foreign Priority claimed	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR COUNTRY ID	SHEETS DRAWING 4	TOTAL CLAIMS 29	INDEPENDENT CLAIMS 15
35 USC 119 (a-d) conditions met	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance				
Verified and Acknowledged	<i>[Signature]</i> Examiner's Signature	Initials			

ADDRESS

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TITLE

Methods for filling high aspect ratio trenches in semiconductor layers

FILING FEE RECEIVED 2050	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit
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